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TENT APPLICATION

ME OF CONVEYING PARTY

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NATURE OF CONVEYANCE

Assignment of U.S. Patent Application

CONVEYANCE EXECUTION DATE

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CORRESPONDENCE

ADDRESS

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ATTORNEY REFERENCE

COR 142

TOTAL NUMBER OF PATENTS

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One

TOTAL FEE PAID

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\$40.00

METHOD OF PAYMENT : [X] E₁

[X] Enclosed

Authorized to be charged to

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Steven M. Rabin (Reg. No. 29,102)

September 9, 2004

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PATENT REEL: 015776 FRAME: 0102

FEE ENCLOSED: \$ 940
Plance charge any further
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for 18-0402

ASSIGNMENT 讓渡書

本讓渡協議書適用的發明,其名稱為: (填入發明名稱) <u>定義積體電路中之最小節距</u> 超越微影製程解析度之方法	WHEREAS this Assignment conveys the specified PATENT RIGHTS to the invention entitled (Invention Title) METHOD AND APPARATUS FOR PREVENTING A FURNACE IN A SEMICONDUCTOR PROCESS FROM TEMPERATURE AND GAS EXCURSION		
本協議書的讓渡人是在本協議書最後簽字的發明人。	AND WHEREAS the ASSIGNOR(S) of the PATENT RIGHTS by this Agreement is (or are) the inventor(s) or patent owner(s) whose signature(s) appear(s) on page 3 of this Assignment and any Supplemental Sheet(s).		
本協議書的受讓人如下:	The ASSIGNEE of the PATENT RIGHTS by this Agreement is:		
(受讓人名字) <u>旺宏電子股份有限公司</u>	(Name of Assignee) Macronix International Co., Ltd.		
(受讓人地址)中華民國台灣省新竹市 300 新	(Address) No. 16, Li-Hsin Road, Science-Based		
竹科學工業園區力行路 16 號	Industrial Park, Hsinchu 300, Taiwan R.O.C.		
受讓人是:	The ASSIGNEE is:		
(注明一項)	(check one)		
□個人	☐ An Individual.		
□	☐ A Partnership.		
□ 日内控告的正案	☐ A Corporation of <u>TAIWAN R.O.C.</u>		
	(specify state or country)		
(塡入公司所在國家名稱) □ (其他)	□ (other)		
本協議書涉及的專利權是:	IT IS AGREED THAT: The PATENT RIGHTS conveyed by this Agreement		
(注明一項)	are:		
	(check one)		
☑ 本發明的專利申請案,該申請案與本讓渡書	□ a patent application for this invention, executed		
同時由讓渡人簽署。	by the ASSIGNOR(S) concurrently with this		
□於(申請日期)提出申	Assignment. ☑ U.S. Patent Application Serial No. 10/871,535		
請的美國專利申請號碼。	, filed		
□ 根據(申請日期)提出	□ a U.S. patent application based on PCT		
的 PCT 國際專利申請號碼	International Application No.		
(美國專利申請號碼	filed on (date)		
的美國專利申請案。)	(U.S. patent application Serial No		
□於(公告日期)公告	, if known).		
的美國專利號碼。	U.S. Patent No.		
ロフノヘビタスナイリングに中心	issued		

PATENT REEL: 015776 FRAME: 0103 專利權也包括上述專利和專利申請案的所有分案,再公告,續展和延長。

根據本協議書讓渡的專利權是:

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- Worldwide patent rights. In this case, the Assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(s), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors, and assigns:

the full and exclusive right to the invention; the entire right, title, and interest in and to the PATENT RIGHTS, for and during the term or terms of any and all such patents when granted; the right to sue and recover for any past infringement of said PATENT RIGHTS; and, the right to claim priority under 35 USC 119,35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this Agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination, and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, made all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, and its successors and assigns, to obtain and enforce the full extent of protection to which it is entitled for said PATENT RIGHTS.

PATENT REEL: 015776 FRAME: 0104 受讓人授權本申請案所委任的律師和代理人對 簽署後的本協議書進行校核,並填入序號和申 請日。

RECORDED: 09/09/2004

茲同意:

The ASSIGNOR(S) authorize(s) any attorneys and agents who have a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

丝 同意:	AGREED:			
Ta Neng Ho Name of sole or first inventor 第一位或獨有的發明者全名	Ja Neug Ho Signature 簽名			
Chung Pin Lin Name of second inventor, if any 第二位發明者全名	Signature	<u>し</u>	<u>July 18, 20</u> Date	004 日期
Lin Wu Yang Name of third inventor, if any 第三位發明者全名	Lin-Wu Ja Signature	_	<u>July 18, 20</u> Date	00 <u>4</u> 日期
Chung Chih Chang Name of fourth inventor, if any 第四位發明者全名	Chang Cha	·A Chany 簽名	<u>July 18, 20</u> Date	日期
Name of fifth inventor, if any 第五位發明者全名	Signature	<u></u> 簽名	Date	 日期
Name of sixth inventor, if any 第六位發明者全名	Signature	簽名	Date	日期
Name of seventh inventor, if any 第七位發明者全名	Signature	 簽名	Date	日期
 Name of eighth inventor, if any 第八位發明者全名	Signature	 簽名	Date	日期

PATENT REEL: 015776 FRAME: 0105